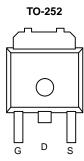


### N-Channel 40-V (D-S) MOSFET

| PRODUCT SUMMARY     |                           |                                    |                      |  |  |  |
|---------------------|---------------------------|------------------------------------|----------------------|--|--|--|
| V <sub>DS</sub> (V) | R <sub>DS(on)</sub> (Ω)   | I <sub>D</sub> (A) <sup>a, e</sup> | Q <sub>g</sub> (Typ) |  |  |  |
| 40                  | 0.013 at $V_{GS}$ = 10 V  | 55                                 | 42 nC                |  |  |  |
| 40                  | 0.018 at $V_{GS}$ = 4.5 V | 45                                 | 42 110               |  |  |  |



Top View

#### **FEATURES**

- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> and UIS Tested
  Compliant to RoHS Directive 2011/65/EU

#### **APPLICATIONS**

- OR-ing ٠
- Server
  - DC/DC G



N-Channel MOSFET

D

C

| ABSOLUTE MAXIMUM RATINGS                             | <b>(</b> T <sub>A</sub> = 25 °C, unle | ess otherwise no | oted)                |    |
|--|---------------------------------------|------------------|----------------------|----|
| Parameter  | Symbol                                | Limit            | Unit                 |    |
| Drain-Source Voltage                                 | V <sub>DS</sub>                       | 40               | V                    |    |
| Gate-Source Voltage                                  |                                       | V <sub>GS</sub>  | ± 20                 | v  |
|  | T <sub>C</sub> = 25 °C                |                  | 55 <sup>a, e</sup>   |    |
| Continuous Drain Current ( $T_1 = 175 \ ^{\circ}C$ ) | T <sub>C</sub> = 70 °C                |                  | 45 <sup>e</sup>      |    |
|  | T <sub>A</sub> = 25 °C                | I <sub>D</sub>   | 15.8 <sup>b, c</sup> | A  |
|  | T <sub>A</sub> = 70 °C                |                  | 12 <sup>b, c</sup>   |    |
| Pulsed Drain Current                                 | I <sub>DM</sub>                       | 200              | $\neg$               |    |
| Avalanche Current Pulse                              | L = 0.1 mH                            |                  | 39                   |    |
| Single Pulse Avalanche Energy                        | L = 0.1 IIIH                          | E <sub>AS</sub>  | 94.8                 | mJ |
| Continuous Source-Drain Diode Current                | T <sub>C</sub> = 25 °C                | I <sub>S</sub>   | 90 <sup>a, e</sup>   | Α  |
| Continuous Source-Drain Diode Current                | T <sub>A</sub> = 25 °C                | 'S               | 3.13 <sup>b, c</sup> | ~  |
|  | T <sub>C</sub> = 25 °C                |                  | 100 <sup>a</sup>     |    |
| Movimum Douter Dissinction                           | T <sub>C</sub> = 70 °C                | P <sub>D</sub>   | 75                   | w  |
| Maximum Power Dissipation                            | T <sub>A</sub> = 25 °C                | 'D               | 3.75 <sup>b, c</sup> | vv |
|  | T <sub>A</sub> = 70 °C                |                  | 2.63 <sup>b, c</sup> | 7  |
| Operating Junction and Storage Temperature Ra        | T <sub>J</sub> , T <sub>stg</sub>     | - 55 to 175      | °C                   |    |

| THERMAL RESISTANCE RATINGS                  |                        |                   |      |      |      |  |
|---|------------------------|-------------------|------|------|------|--|
| Parameter                                   |                        | Symbol            | Тур. | Max. | Unit |  |
| Maximum Junction-to-Ambient <sup>b, d</sup> | $t \le 10 \text{ sec}$ | R <sub>thJA</sub> | 32   | 40   | °C/W |  |
| Maximum Junction-to-Case                    | Steady State           | R <sub>thJC</sub> | 0.5  | 0.6  | 0/11 |  |

Notes:

a. Based on  $T_C = 25 \text{ °C}$ . b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 sec.
d. Maximum under steady state conditions is 90 °C/W.
e. Calculated based on maximum junction temperature. Package limitation current is 90 A.

### NTD5806NT4G

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| Parameter                                     | Symbol                  | Test Conditions   | Min. | Тур.  | Max.  | Unit   |  |
|---|-------------------------|---|------|-------|-------|--------|--|
| Static  |                         |   |      |       |       | •      |  |
| Drain-Source Breakdown Voltage                | V <sub>DS</sub>         | $V_{GS} = 0 V, I_{D} = 250 \mu A$   | 40   |       |       | V      |  |
| V <sub>DS</sub> Temperature Coefficient       | $\Delta V_{DS}/T_{J}$   | L = 250 µA  |      | 35    |       | m\//°C |  |
| V <sub>GS(th)</sub> Temperature Coefficient   | $\Delta V_{GS(th)}/T_J$ | I <sub>D</sub> = 250 μA   |      | - 7.5 |       | mV/°C  |  |
| Gate-Source Threshold Voltage                 | V <sub>GS(th)</sub>     | $V_{DS} = V_{GS}, I_D = 250 \ \mu A$  | 1.5  |       | 2.5   | V      |  |
| Gate-Source Leakage                           | I <sub>GSS</sub>        | $V_{DS} = 0 V, V_{GS} = \pm 20 V$   |      |       | ± 100 | nA     |  |
| Zara Cata Malta na Drain Current              | 1                       | $V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$   |      |       | 1     | μA     |  |
| Zero Gate Voltage Drain Current               | IDSS                    | $V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$                                  |      |       | 10    |        |  |
| On-State Drain Current <sup>a</sup>           | I <sub>D(on)</sub>      | $V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$   | 90   |       |       | А      |  |
|   |                         | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 38.8 A   |      | 0.012 |       | Ω      |  |
| Drain-Source On-State Resistance <sup>a</sup> | R <sub>DS(on)</sub>     | $V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 37 \text{ A}$  |      | 0.014 |       |        |  |
| Forward Transconductance <sup>a</sup>         | 9 <sub>fs</sub>         | V <sub>DS</sub> = 15 V, I <sub>D</sub> = 38.8 A   |      | 160   |       | S      |  |
| Dynamic <sup>b</sup>                          |                         |   |      |       |       |        |  |
| Input Capacitance                             | C <sub>iss</sub>        |   |      | 1801  |       |        |  |
| Output Capacitance                            | C <sub>oss</sub>        | $V_{DS}$ = 15 V, $V_{GS}$ = 0 V, f = 1 MHz  |      | 725   |       | pF     |  |
| Reverse Transfer Capacitance                  | C <sub>rss</sub>        |   |      | 570   |       |        |  |
| Total Gate Charge                             | Q <sub>g</sub>          | $V_{DS}$ = 15 V, $V_{GS}$ = 10 V, $I_{D}$ = 38.8 A  |      | 85    | 120   | nC     |  |
|   |                         |   |      | 42    | 62    |        |  |
| Gate-Source Charge                            | Q <sub>gs</sub>         | $V_{DS}$ = 15 V, $V_{GS}$ = 4.5 V, $I_{D}$ = 28.8 A   |      | 17    |       |        |  |
| Gate-Drain Charge                             | Q <sub>gd</sub>         |   |      | 14    |       |        |  |
| Gate Resistance                               | R <sub>g</sub>          | f = 1 MHz   |      | 1.4   | 2.1   | Ω      |  |
| Turn-On Delay Time                            | t <sub>d(on)</sub>      |   |      | 10    | 20    | -      |  |
| Rise Time                                     | t <sub>r</sub>          | $V_{DD}$ = 15 V, $R_L$ = 0.625 $\Omega$   |      | 11    | 17    |        |  |
| Turn-Off Delay Time                           | t <sub>d(off)</sub>     | $\text{I}_\text{D} \cong$ 24 A, $\text{V}_\text{GEN}$ = 10 V, $\text{R}_\text{g}$ = 1 $\Omega$        |      | 35    | 55    |        |  |
| Fall Time                                     | t <sub>f</sub>          |   |      | 10    | 15    |        |  |
| Turn-On Delay Time                            | t <sub>d(on)</sub>      |   |      | 25    | 43    | ns     |  |
| Rise Time                                     | t <sub>r</sub>          | $V_{DD}$ = 15 V, $R_L$ = 0.67 $\Omega$  |      | 80    | 150   |        |  |
| Turn-Off Delay Time                           | t <sub>d(off)</sub>     | $\text{I}_\text{D}\cong$ 22.5 A, $\text{V}_\text{GEN}$ = 4.5 V, $\text{R}_\text{g}$ = 1 $\Omega$      |      | 26    | 42    |        |  |
| Fall Time                                     | t <sub>f</sub>          |   |      | 12    | 18    | 1      |  |
| Drain-Source Body Diode Characteristics       | <u> </u>                |   |      |       |       |        |  |
| Continuous Source-Drain Diode Current         | ا <sub>S</sub>          | $T_{\rm C} = 25 \ ^{\circ}{\rm C}$  |      |       | 120   | ۵      |  |
| Pulse Diode Forward Current <sup>a</sup>      | I <sub>SM</sub>         |   |      |       | 120   | A      |  |
| Body Diode Voltage                            | $V_{SD}$                | I <sub>S</sub> = 22 A   |      | 0.8   | 1.2   | V      |  |
| Body Diode Reverse Recovery Time              | t <sub>rr</sub>         |   |      | 52    | 78    | ns     |  |
| Body Diode Reverse Recovery Charge            | Q <sub>rr</sub>         | I <sub>F</sub> = 20 A, di/dt = 100 A/μs, T <sub>J</sub> = 25 °C                                       |      | 70.2  | 105   | nC     |  |
| Reverse Recovery Fall Time                    | t <sub>a</sub>          | $r_F = 20 \text{ A}, \text{ al/al} = 100 \text{ A/}\mu\text{s},  \text{I}_{\text{J}} = 25 \text{ °C}$ |      | 27    |       |        |  |
| Reverse Recovery Rise Time                    | t <sub>b</sub>          |   |      | 25    |       | ns     |  |

Notes:

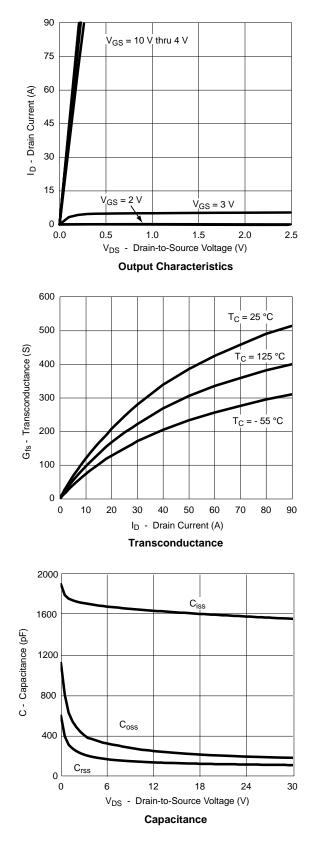
a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2$  %.

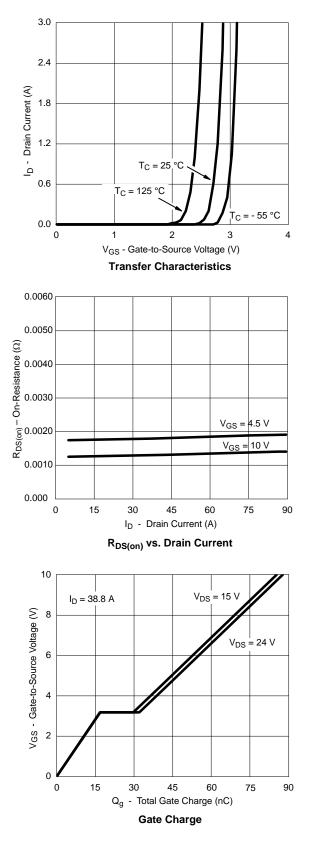
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





0.001

0.000

0

2

4

6

 $V_{GS}$  - Gate-to-Source Voltage (V)

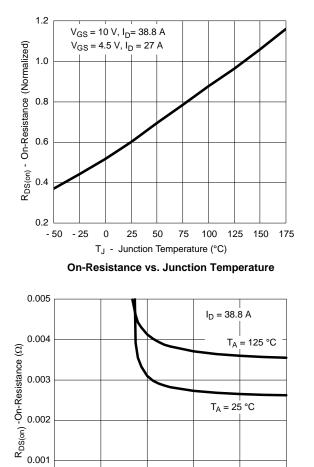
 $R_{DS(on)}$  vs.  $V_{GS}$  vs. Temperature

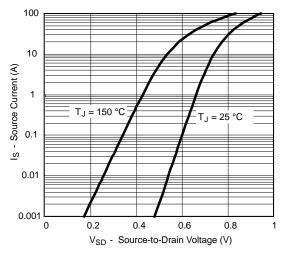
8

10

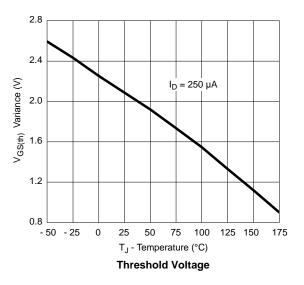


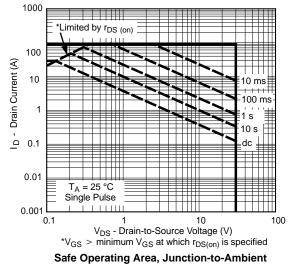
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



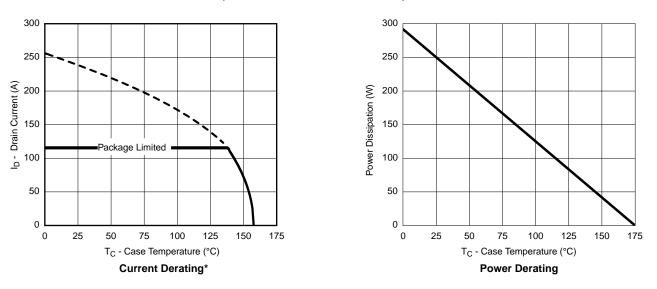


Forward Diode Voltage vs. Temperature

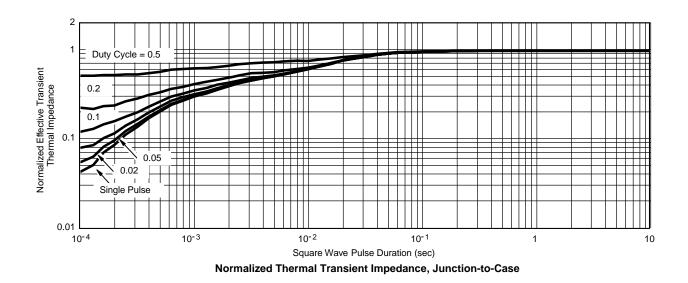




limit.



# \*The power dissipation $P_D$ is based on $T_{J(max)}$ = 175 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package

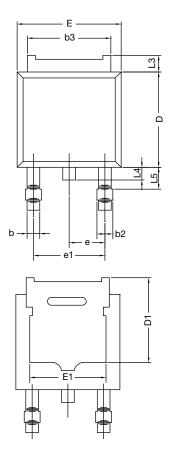


#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

semi



# **TO-252AA CASE OUTLINE**





|  | MILLIN | IETERS   | INCHES |           |  |  |
|--|--------|----------|--------|-----------|--|--|
| DIM.   | MIN.   | MAX.     | MIN.   | MAX.      |  |  |
| А  | 2.18   | 2.38     | 0.086  | 0.094     |  |  |
| A1   | -      | 0.127    | -      | 0.005     |  |  |
| b  | 0.64   | 0.88     | 0.025  | 0.035     |  |  |
| b2   | 0.76   | 1.14     | 0.030  | 0.045     |  |  |
| b3   | 4.95   | 5.46     | 0.195  | 0.215     |  |  |
| С  | 0.46   | 0.61     | 0.018  | 0.024     |  |  |
| C2   | 0.46   | 0.89     | 0.018  | 0.035     |  |  |
| D  | 5.97   | 6.22     | 0.235  | 0.245     |  |  |
| D1   | 5.21   | -        | 0.205  | -         |  |  |
| Е  | 6.35   | 6.73     | 0.250  | 0.265     |  |  |
| E1   | 4.32   | -        | 0.170  | -         |  |  |
| Н  | 9.40   | 10.41    | 0.370  | 0.410     |  |  |
| е  | 2.28   | 2.28 BSC |        | BSC       |  |  |
| e1   | 4.56   | 4.56 BSC |        | 0.180 BSC |  |  |
| L  | 1.40   | 1.78     | 0.055  | 0.070     |  |  |
| L3   | 0.89   | 1.27     | 0.035  | 0.050     |  |  |
| L4   | -      | 1.02     | -      | 0.040     |  |  |
| L5   | 1.14   | 1.52     | 0.045  | 0.060     |  |  |
| ECN: X12-0247-Rev. M, 24-Dec-12<br>DWG: 5347 |        |          |        |           |  |  |

#### Note

• Dimension L3 is for reference only.



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